

# **General Description**

The AO3434 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge.

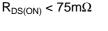
This device is suitable for use as a load switch or in PWM applications. It is ESD protected.

## **Features**

 $V_{DS}(V) = 30V$ 

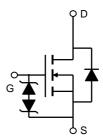
 $I_{D} = 4.2A$  $(V_{GS} = 10V)$ 

 $(V_{GS} = 10V)$  $R_{DS(ON)} < 52m\Omega$  $(V_{GS} = 4.5V)$ 



ESD protected





		Maximum				
Parameter		Symbol	10 sec	Steady-State	Units	
Drain-Source Voltage		V <sub>DS</sub>	30		V	
Gate-Source Voltage		V <sub>GS</sub>		±20	V	
Continuous Drain	T <sub>A</sub> =25℃		4.2	3.5		
Current A,F	T <sub>A</sub> =70℃	I <sub>D</sub>	3.3	2.8	А	
Pulsed Drain Current <sup>B</sup>		I <sub>DM</sub>	30			
	T <sub>A</sub> =25℃	– P <sub>D</sub>	1.4	1.0	14/	
Power Dissipation	T <sub>A</sub> =70℃	гD	0.9	0.64	W	
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150		C	

Thermal Characteristics							
Parameter	Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient <sup>A</sup>	t ≤ 10s	P	70	90	C/W		
Maximum Junction-to-Ambient A	Steady-State	$R_{\thetaJA}$	100	125	c/M		
Maximum Junction-to-Lead <sup>C</sup>	Steady-State	$R_{ ext{ hetaJL}}$	63	80	c/M		



AO3434 30V N-Channel MOSFET

#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC F	PARAMETERS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V		30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V				1	μA
			T_=55℃			5	μA
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 16V$				10	uA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$		1	1.32	1.8	V
I <sub>D(ON)</sub>	On state drain current	$V_{GS}$ =10V, $V_{DS}$ =5V		30			Α
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =4.2A			43	52	mΩ
			T <sub>J</sub> =125℃		58	74	11122
		$V_{GS}$ =4.5V, $I_{D}$ =2A			59	75	mΩ
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =4.2A		8.5		S	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =1A,V <sub>GS</sub> =0V		0.77	1	V	
I <sub>S</sub>	Maximum Body-Diode Continuous Cur	rent		1.8	Α		
DYNAMIC	PARAMETERS						
C <sub>iss</sub>	Input Capacitance			269	340	pF	
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1MHz			65		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				41		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz			1	1.5	Ω
SWITCHI	NG PARAMETERS						
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =4.2A			5.7	7.2	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge				3		nC
Q <sub>gs</sub>	Gate Source Charge				1.37		nC
Q <sub>gd</sub>	Gate Drain Charge				0.65		nC
t <sub>D(on)</sub>	Turn-On DelayTime	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, R <sub>L</sub> =3.6Ω, R <sub>GEN</sub> =3Ω			2.6	3.8	ns
t <sub>r</sub>	Turn-On Rise Time				5.5	8	ns
t <sub>D(off)</sub>	Turn-Off DelayTime				15.2	23	ns
t <sub>f</sub>	Turn-Off Fall Time				3.7	5.5	ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =4.2A, dI/dt=100A/μs			15.5	21	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	, I <sub>F</sub> =4.2A, dI/dt=100A/µ		7.1		nC	

A: The value of R  $_{0.JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T  $_A$ =25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\rm \theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\rm \theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300  $\mu$ s pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in <sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

F.The current rating is based on the t $\leq$ 10s thermal resistance rating.

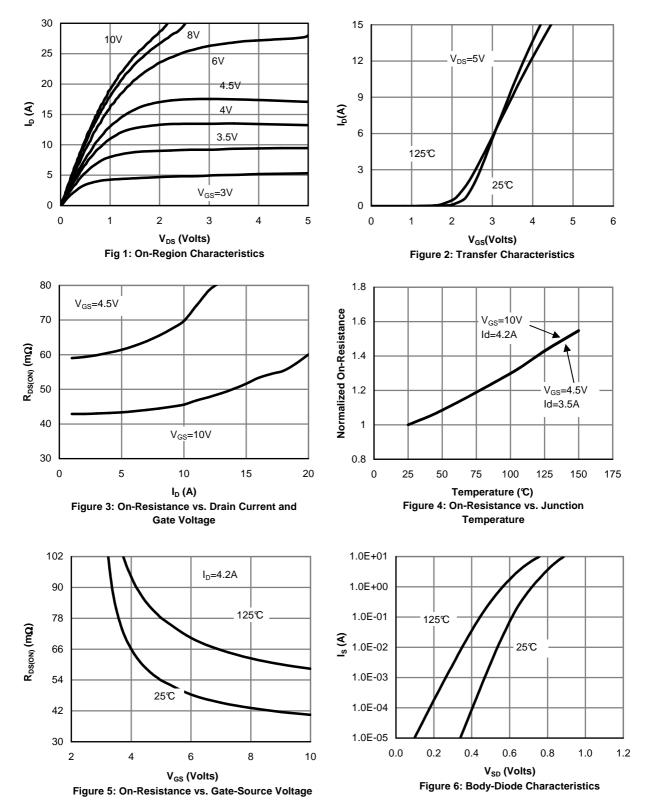
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30V N-Channel MOSFET

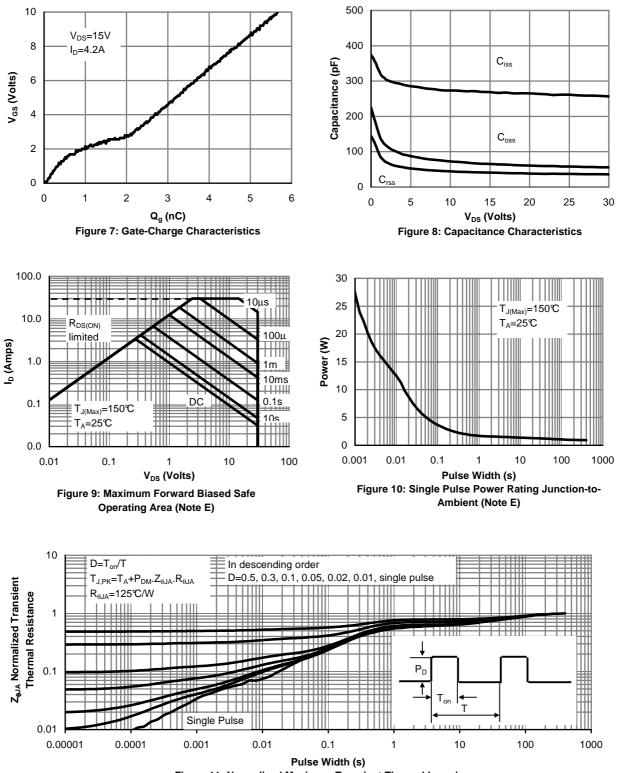
### **TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**





AO3434 30V N-Channel MOSFET

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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